Memory Microcircuit - Page 1 of 1



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Maximum Power Dissipation Rating:
1500.0 milliwatts
Operating Tempurature Range:
-55.0/+125.0 degrees celsius
Storage Tempurature Range:
-65.0/+150.0 degrees celsius
End Application:
Next assembly: 8517702-902 used o (sys): 8515143.920
Features Provided:
Burn in and high performance and macrologic and programmed and ultraviolet erasable and tested to mil-std-883
Inclosure Configuration:
Leaded chip carrier
Output Logic Form:
Complementary-metal oxide-semiconductor logic
Product Name:
32-macrocell maximum epId
Voltage Rating And Type Per Characteristic:
-2.0 volts applied and 7.0 volts applied
Memory Device Type:
Pal
Hybrid Technology Type:
Monolithic
Test Data Document:
81349-mil-m-38510 specification (includes engineering type bulletins, brochures, etc., that reflect specification type data in specification
format; excludes commercial catalogs, industry directories, and similar trade publications, reflecting general type data on certain

environmental and performance requirements and test conditions that are shown as "typical", "average", "", etc.).

Terminal Type And Quantity:

28 j-hook

Departure From Cited Designator:

Progammed per: ps8518594-11 (prod software for f-16 updg clr grph cont-a2 cca)

Shelf Life:

N/a

Unit Of Measure:

Demilitarization:

Yes - demil/mli

Fiig:

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